TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC166P,TC74AC166F

8-Bit Shift Register (P-IN, S-OUT)

The TC74AC166 is an advanced high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate and double-layer metal wiring  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

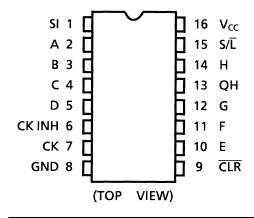
It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock input and an overriding clear input. The parallel-in or serial-in modes are controlled by the SHIFT/  $\overline{\text{LOAD}}$  input. When the SHIFT/  $\overline{\text{LOAD}}$  input is held high, the serial data input is enabled and the eight flip-flops perform serial shifting on each clock pulse. When held low, the parallel data inputs are enabled and synchronous loading occurs on the next clock pulse. Clocking is accomplished on the low-to-high transition of the clock pulse. The CLOCK-INHIBIT input should be shifted high only while the CLOCK input is held high. A direct clear input overrides all other inputs, including the clock, and sets all the flip-flops to zero. Functional details are shown in the truth table and the timing charts.

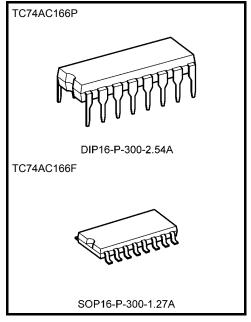
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $f_{max} = 170 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 8 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24$  mA (min) Capability of driving 50  $\Omega$  transmission lines.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Pin and function compatible with 74HC166

#### **Pin Assignment**

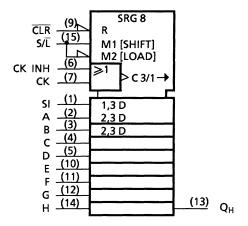




Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

# **IEC Logic Symbol**



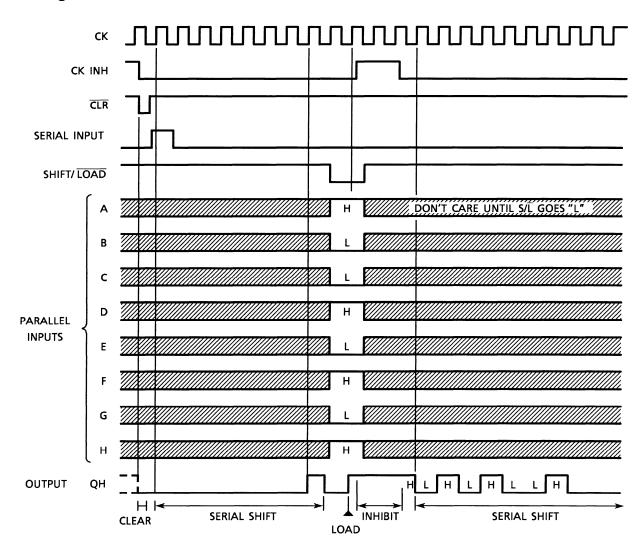
### **Truth Table**

Inputs							Output	
CLR	SHIFT/ LOAD	CK INH.	СК	SERIAL IN			QH	
L	Х	Х	Х	Х	Х	L L	L	
Н	Х	Х	$\neg$	Х	Х	No Ch	nange	
Н	L	L		Х	a·····h	a b	h	
Н	Н	L		Н	Х	H QAn	QGn	
Н	Н	L		L	Х	L QAn	QGn	
Н	Х	Н	Х	Х	Х	No Ch	nange	

X: Don't care

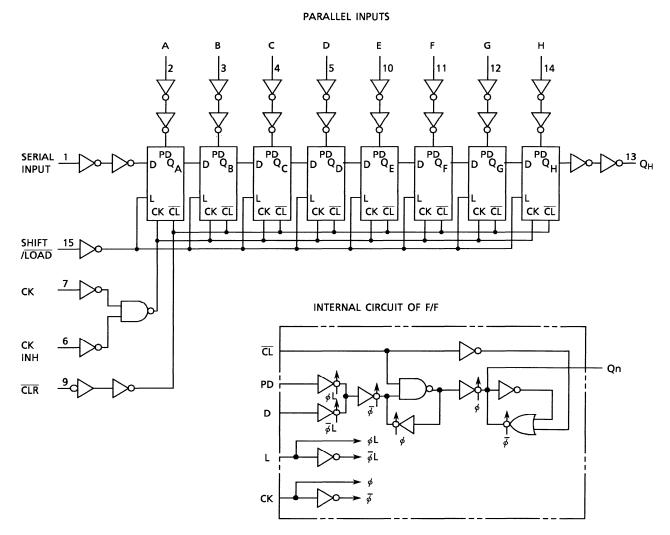
 $a \cdot \dots \cdot h \text{: The level of steady state input voltage at inputs A through H respectively}$ 

# **Timing Chart**



3

#### **System Diagram**



### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lıĸ	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±100	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.



# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V $_{CC} = 3.3 \pm 0.3$ V)	ns/V	
input rise and fail time	αναν	0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )		

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit		
Characteristics	Зупівої				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Offic	
		_			2.0	1.50	_	_	1.50	_		
High-level input voltage	$V_{IH}$				3.0	2.10	_	_	2.10	_	V	
3.0				5.5	3.85	_	_	3.85	_			
					2.0		_	0.50	_	0.50		
Low-level input voltage	$V_{IL}$		_		3.0	_	_	0.90	_	0.90	V	
				5.5		_	1.65	_	1.65			
	V <sub>ОН</sub>				2.0	1.9	2.0	_	1.9	_		
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		3.0	2.9	3.0	_	2.9	_	V	
High-level output					4.5	4.4	4.5	_	4.4			
voltage			$I_{OH} = -4 \text{ mA}$		3.0	2.58	_	_	2.48		v	
			$I_{OH} = -24 \text{ mA}$		4.5	3.94	_	_	3.80	_		
			$I_{OH} = -75 \text{ mA}$	(Note)	5.5		_	_	3.85			
		V <sub>IN</sub> = V <sub>IH</sub> or			2.0		0.0	0.1	_	0.1		
			$I_{OL} = 50 \mu A$		3.0	_	0.0	0.1	_	0.1		
Low-level output	V <sub>OL</sub>				4.5		0.0	0.1	_	0.1	V	
voltage	VOL	VIL	$I_{OL} = 12 \text{ mA}$		3.0	_	_	0.36	_	0.44	v	
			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44		
			$I_{OL} = 75 \text{ mA}$	(Note)	5.5	_	_	_	_	1.65		
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	l		±0.1		±1.0	μΑ		
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	8.0	_	80.0	μΑ		

5

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.



### Timing Requirements (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C	Ta = -40 to 85°C	Unit	
			V <sub>CC</sub> (V)	Limit	Limit	
Minimum pulse width	t <sub>W (H)</sub>		$3.3 \pm 0.3$	7.0	7.0	no
(CK)	t <sub>W (L)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum pulse width	<b>4</b>		$3.3 \pm 0.3$	8.0	8.0	20
(CLR)	t <sub>W (L)</sub>	_	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum set-up time			$3.3 \pm 0.3$	8.0	8.0	20
(SI, PI)	t <sub>S</sub>	_	$5.0 \pm 0.5$	4.0	4.0	ns
Minimum set-up time			$3.3 \pm 0.3$	7.0	7.0	20
(S/L)	t <sub>S</sub>	_	$5.0 \pm 0.5$	4.0	4.0	ns
Minimum hold time	4.		$3.3 \pm 0.3$	0.5	0.5	20
(SI, PI)	t <sub>h</sub>	_	$5.0 \pm 0.5$	0.5	0.5	ns
Minimum hold time	4.		$3.3 \pm 0.3$	1.0	1.0	20
(S/L)	t <sub>h</sub>	_	$5.0 \pm 0.5$	1.0	1.0	ns
Minimum removal time	+		$3.3 \pm 0.3$	4.0	4.0	20
(CLR)	t <sub>rem</sub>	_	$5.0 \pm 0.5$	1.5	1.5	ns

### AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: $t_r$ = $t_f$ = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	-,		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay time (CK-QH)	t <sub>pLH</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	_	9.4 6.6	16.1 10.0	1.0 1.0	18.3 11.4	ns
Propagation delay time (CLR -QH)	t <sub>pHL</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$		9.2 6.4	15.2 9.6	1.0 1.0	17.4 10.9	ns
Maximum clock frequency	f <sub>max</sub>	_	$3.3 \pm 0.3$ $5.0 \pm 0.5$	55 90	105 150	_	55 90	_	MHz
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	_		_	67	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

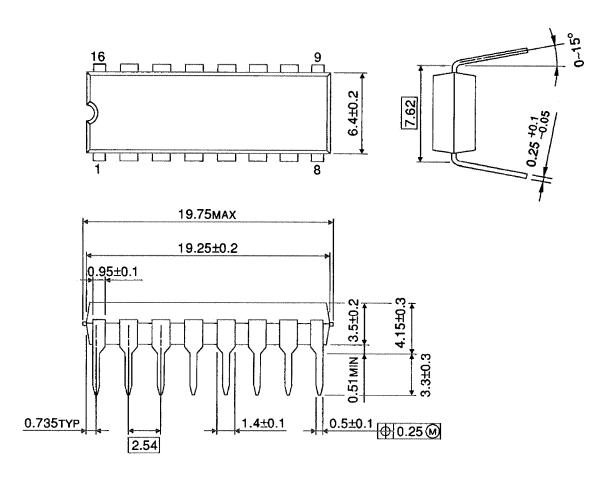
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

6 2012-02-29

# **Package Dimensions**

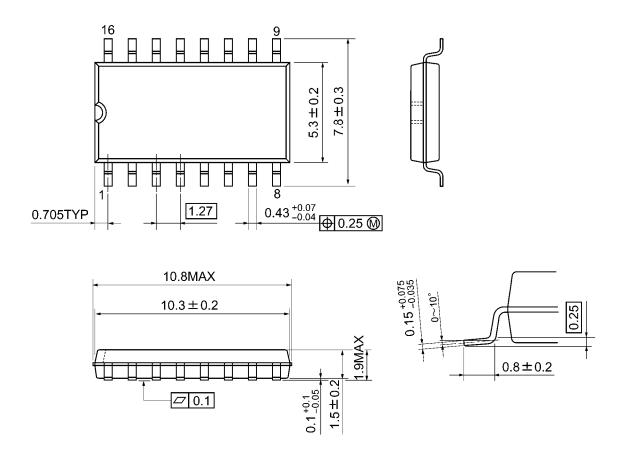
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

# **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



8

Weight: 0.18 g (typ.)

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9